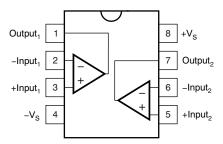


DEM-OPA-MSOP-2A Demonstration Fixture

1 Description

The DEM-OPA-MSOP-2A demonstration fixture is a generic, unpopulated printed circuit board (PCB) for dual high-speed operational amplifiers in MSOP-8 packages. Figure 1 shows the package pinout for this PCB. For more information on these op amps, as well as good PCB layout techniques, see the individual amplifier data sheets.





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1



Circuit

2 Circuit

The circuit schematic in Figure 2 shows the connections for all possible components. Each configuration uses only some of the components.

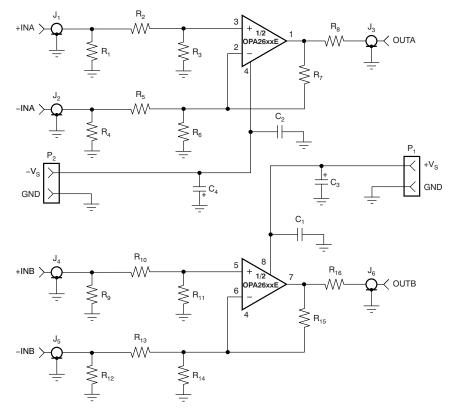


Figure 2. Schematic for DEM-OPA-MSOP-2A

3 Components

Components that have RF performance similar to the ones listed in Table 1 may be substituted.

| PART | DESCRIPTION |
|---------------------------------|---|
| C ₁ , C ₂ | Multilayer Ceramic Chip Capacitor, Size 1206, 20V |
| C ₃ , C ₄ | Tantalum Chip Capacitor, Size 3528, 16V |
| $R_1 - R_{16}$ | Metal Film Chip Resistor, Size 1206, 1/8W |
| $J_1 - J_6$ | SMA or SMB Board Jack (Amphenol 901-144-8) |
| P ₁ , P ₂ | Power Connectors (On-Shore Technology ED555/2DS) |

Table 1. Component Descriptions

Resistors R_1 , R_4 , R_9 and R_{12} are used to set the input impedance. Resistors R_8 and R_{16} set the output impedance. The values in Table 2 support test equipment with 50 Ω input and output impedances; other source and load impedances are easily accommodated.

Table 2 lists suggested component values for the a dual voltage feedback operational amplifier in three different configurations: as a Noninverting Amplifier (NIA), an Inverting Amplifier (IA) and a Difference Amplifier (DA). The gain for the DA is the differential mode gain. Other dual op amps can also be easily configured; consult the respective data sheet for a specific op amp to select component values.

| CONFIGURATION | NONINVERTING | INVERTING | DIFFERENCE |
|----------------------------------|-------------------|-------------------|---------------------|
| Gain | +2 | -1 | +1 |
| C ₁ , C ₂ | 0.1µF | 0.1µF | 0.1µF |
| C ₃ , C ₄ | 4.7µF | 4.7µF | 4.7μF |
| R ₁ , R ₉ | 49.9Ω | Not used | 53.6Ω |
| R ₂ , R ₁₀ | 20.0Ω | Not used | 402Ω |
| R ₃ , R ₁₁ | Not used | 20.0Ω | 402Ω |
| R ₄ , R ₁₂ | Not used | 56.2Ω | 61.9Ω |
| R ₅ , R ₁₃ | Not used | $R_G = 402\Omega$ | $R_{G} = 402\Omega$ |
| R ₆ , R ₁₄ | $R_G = 402\Omega$ | Not used | Not used |
| R ₇ , R ₁₅ | $R_F = 402\Omega$ | $R_F = 402\Omega$ | $R_F = 402\Omega$ |
| R ₈ , R ₁₆ | 49.9Ω | 49.9Ω | 49.9Ω |

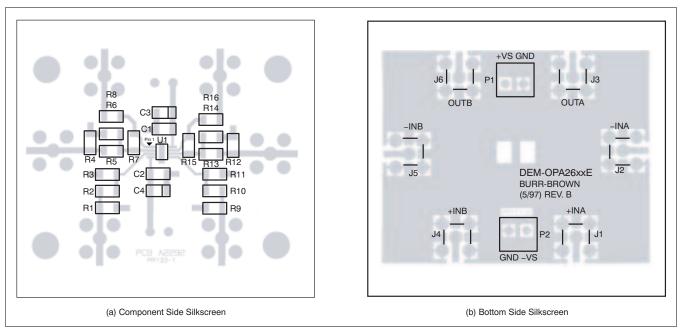
Table 2. Example Component Selection Guide⁽¹⁾⁽²⁾

 $^{(1)}$ The values listed here are for illustration purposes only. See the individual op amp data sheet for information on selecting these values. See the specific data sheet to select proper values. The I/O impedances are 50 Ω .

⁽²⁾ R_F and R_G refer to the *feedback* and *gain-setting* resistors for current-feedback op amps.

4 Board Layout

This demonstration fixture is a two-layer PCB. (See Figure 3.) It uses a ground plane on the bottom layer, and signal and power traces on the top layer. The ground plane has been opened up around op amp pins that are sensitive to capacitive loading. Power-supply traces are laid out to keep current loop areas to a minimum. The SMA (or SMB) connectors may be mounted either vertically or horizontally onto the board edge.



(1) The board name shown in the silkscreen is DEM-OPA26xxE with the Burr-Brown Revision B design finalized in May 1997.

Figure 3. DEM-OPA-MSOP-2A Demonstration Board Layout



Measurement Tips

The location and type of capacitors used for power-supply bypassing are crucial for high-frequency amplifiers. The tantalum capacitors, C_3 and C_4 , do not need to be close to pins 8 and 4 on the PCB and may be shared with other amplifiers. See the individual op amp data sheet for more information on proper board layout techniques and component selection.

5 Measurement Tips

This demonstration fixture, with the component values shown, is designed to operate in a 50 Ω environment; most data sheet plots are obtained under these conditions. It is easy to change the component values for different input and output impedance levels. However, do not use high-impedance probes; they represent a heavy capacitive load to the op amp, and will alter the amplifier response. Instead, use low-impedance ($\leq 500\Omega$) probes with adequate bandwidth. The probe input capacitance and resistance set an upper limit on the measurement bandwidth. If a high-impedance probe must be used, place a 100 Ω resistor on the probe tip to isolate its capacitance from the circuit.

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